



DDTA (LO-R1) U

PNP PRE-BIASED 100 mA SOT-323 SURFACE MOUNT TRANSISTOR

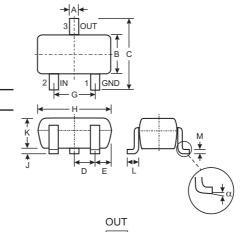
Features

- Epitaxial Planar Die Construction
- Complementary NPN Types Available (DDTC)
- Built-In Biasing Resistors
- Lead Free/RoHS Compliant (Note 2)
- "Green" Device (Note 3 & 4)

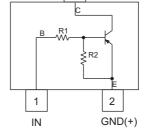
Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 4. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe)
- Marking: Date Code and Type Code, See Page 2
- Ordering Information (See Page 2)
- Weight: 0.006 grams (approximate)

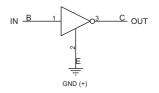
P/N	R1 (NOM)	R2 (NOM)	Type Code
DDTA122LU	0.22KΩ	10KΩ	P81
DDTA142JU	0.47KΩ	10KΩ	P82
DDTA122TU	0.22KΩ	OPEN	P83
DDTA142TU	0.47KΩ	OPEN	P84



SOT-323								
Dim	Min	Max						
Α	0.25	0.40						
В	1.15	1.35						
С	2.00	2.20						
D	0.65 N	ominal						
E	0.30	0.40						
G	1.20	1.40						
Н	1.80	2.20						
J	0.0	0.10						
K	0.90	1.00						
L	0.25	0.40						
M	0.10	0.18						
α	0°	8°						
All Din	nensions	in mm						



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Schematic and Pin Configuration

Equivalent Inverter Circuit

Maximum Ratings @ T_A = 25°C unless otherwise specified

Characteris	tic	Symbol	Value	Unit
Supply Voltage, (3) to (2)		V _{CC}	-50	V
Input Voltage, (1) to (2)	DDTA122LU DDTA142JU	V _{IN}	+5 to -6 +5 to -6	V
Input Voltage, (2) to (1)	DDTA122TU DDTA142TU	V _{EBO} (MAX)	-5	V
Output Current	All	Ic	-100	mA
Power Dissipation (Note 1)		Pd	200	mW
Thermal Resistance, Junction to Ambient Air (Note 1)		$R_{\theta JA}$	625	°C/W
Operating and Storage and Temper	ature Range	T _j , T _{STG}	-55 to +150	°C

Note: 1. Mounted on FR4 PC Board with recommended pad layout at http://www.diodes.com/datasheets/ap02001.pdf.

- 2. No purposefully added lead.
- 3. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- 4. Product manufactured with Date Code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior Date Code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.



Electrical Characteristics @ T_A = 25°C unless otherwise specified

R1, R2 Types

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
Input Voltage	DDTA122LU DDTA142JU	$V_{I(off)} \\$	-0.3 -0.3	_	_	V	$V_{CC} = -5V$, $I_{O} = -100 \mu A$
	DDTA122LU DDTA142JU	$V_{I(on)}$	_	_	-2.0 -2.0	٧	$V_O = -0.3V$, $I_O = -20mA$ $V_O = -0.3V$, $I_O = -20mA$
Output Voltage	Output Voltage		_	_	-0.3V	V	$I_0/I_1 = -5$ mA/-0.25mA
Input Current	DDTA122LU DDTA142JU	II	_	_	-28 -13	mA	V _I = -5V
Output Current		$I_{O(off)}$	_	_	-0.5	μА	$V_{CC} = -50V, V_I = 0V$
DC Current Gain	DDTA122LU DDTA142JU	Gı	56 56	_	_	_	$V_O = -5V$, $I_O = -10mA$
Gain-Bandwidth Product*		f⊤	_	200	_	MHz	$V_{CE} = -10V$, $I_{E} = -5mA$, $f = 100MHz$

^{*} Transistor - For Reference Only

Electrical Characteristics @ T_A = 25°C unless otherwise specified

R1-Only Types

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
Collector-Base Breakdown Voltag	е	BV _{CBO}	-50	_	_	V	I _C = -50μA
Collector-Emitter Breakdown Volta	age	BV _{CEO}	-40	_	_	V	I _C = -1mA
Emitter-Base Breakdown Voltage	BV _{EBO}	-5	_	_	V	$I_E = -50 \mu A$ $I_E = -50 \mu A$	
Collector Cutoff Current		I _{CBO}	_	_	-0.5	μΑ	V _{CB} = -50V
Emitter Cutoff Current DDTA122TU DDTA142TU		I _{EBO}	_	_	-0.5 -0.5	μА	V _{EB} = -4V
Collector-Emitter Saturation Volta	ge	V _{CE(sat)}	_	_	-0.3	V	$I_C = -5mA, I_B = -0.25mA$
DC Current Transfer Ratio DDTA122TU DDTA142TU		h _{FE}	100 100	250 250	600 600	_	I _C = -1mA, V _{CE} = -5V
Gain-Bandwidth Product*		f⊤	_	200	_	MHz	V _{CE} = -10V, I _E = 5mA, f = 100MHz

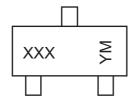
^{*} Transistor - For Reference Only

Ordering Information (Note 4 & 5)

Device	Packaging	Shipping
DDTA122LU-7-F	SOT-323	3000/Tape & Reel
DDTA142JU-7-F	SOT-323	3000/Tape & Reel
DDTA122TU-7-F	SOT-323	3000/Tape & Reel
DDTA142TU-7-F	SOT-323	3000/Tape & Reel

Notes: 4. Product manufactured with Date Code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior Date Code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

Marking Information



XXX = Product Type Marking Code, See Table on Page 1 YM = Date Code Marking Y = Year ex: T = 2006

Y = Year ex: T = 2006 M = Month ex: 9 = September

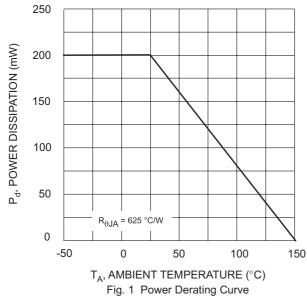
Date Code Key

Year	2006	2007	2008	2009	2010	2011	2012
Code	Т	U	V	W	Х	Υ	Z

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

^{5.} For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.





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